

## N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

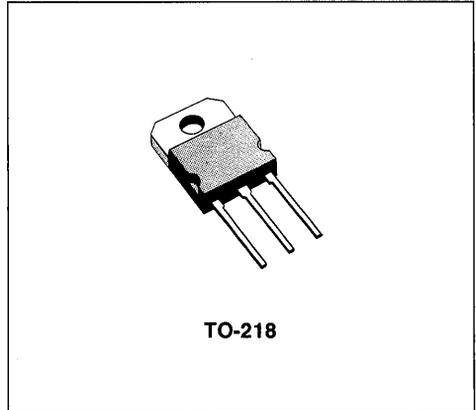
TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
SGSP471	100 V	0.075 Ω	30 A
SGSP472	80 V	0.05 Ω	35 A

- HIGH SPEED SWITCHING APPLICATIONS
- 80 - 100 VOLTS - FOR DC/DC CONVERTERS
- HIGH CURRENT > 1V DROP AT 20A
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- ULTRA FAST SWITCHING
- EASY DRIVE FOR REDUCED SIZE AND COST

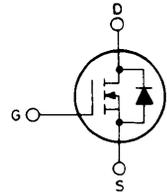
### INDUSTRIAL APPLICATIONS:

- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistors. Easy drive and very fast switching times make these POWER MOS transistors ideal for high speed switching applications. Applications include DC/DC converters, UPS, battery chargers, secondary regulators, servo control, power audio amplifiers and robotics.



### INTERNAL SCHEMATIC DIAGRAM



### ABSOLUTE MAXIMUM RATINGS

	SGSP471	SGSP472	
V <sub>DS</sub>	100	80	V
V <sub>DGR</sub>	100	80	V
V <sub>GS</sub>		±20	V
I <sub>D</sub>	30	35	A
I <sub>D</sub>	19	22	A
I <sub>DM</sub> (*)	120	140	A
P <sub>tot</sub>		150	W
		1.2	W/°C
T <sub>stg</sub>	-65 to 150		°C
T <sub>j</sub>	150		°C

(\*) Pulse width limited by safe operating area  
 ♦ Introduced in 1988 week 44

**THERMAL DATA**

$R_{thj - case}$	Thermal resistance junction-case	max	0.83	°C/W
$T_L$	Maximum lead temperature for soldering purpose		275	°C

**ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25^{\circ}C$  unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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**OFF**

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu A$ for <b>SGSP471</b> for <b>SGSP472</b>	$V_{GS} = 0$	100 80		V V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max Rating}$ $V_{DS} = \text{Max Rating} \times 0.8$	$T_c = 125^{\circ}C$		250 1000	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 V$			$\pm 100$	nA

**ON (\*)**

$V_{GS (th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 250 \mu A$	2		4	V
$R_{DS (on)}$	Static drain-source on resistance	$V_{GS} = 10 V$ $I_D = 15 A$ for <b>SGSP471</b> $I_D = 17.5 A$ for <b>SGSP472</b> $V_{GS} = 10 V$ $I_D = 15 A$ for <b>SGSP471</b> $I_D = 17.5 A$ for <b>SGSP472</b>	$T_c = 100^{\circ}C$			0.075 0.05 0.15 0.1	$\Omega$ $\Omega$ $\Omega$ $\Omega$

**ENERGY TEST**

$I_{UIS}$	Unclamped inductive switching current (single pulse)	$V_{DD} = 30 V$ starting $T_j = 25^{\circ}C$ for <b>SGSP471</b> for <b>SGSP472</b>	$L = 100 \mu H$	30 35			A A
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**DYNAMIC**

$g_{fs}$	Forward transconductance	$V_{DS} = 25 V$	$I_D = 17.5 A$	9			mho
$C_{iss}$	Input capacitance	$V_{DS} = 25 V$	$f = 1 MHz$		1800	2200	pF
$C_{oss}$	Output capacitance	$V_{GS} = 0$				810	pF
$C_{rss}$	Reverse transfer capacitance					375	pF

## ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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## SWITCHING

$t_{d(on)}$	Turn-on time	$V_{DD} = 50\text{ V}$	$I_D = 17.5\text{ A}$	30	40	ns
$t_r$	Rise time	$V_i = 10\text{ V}$	$R_i = 4.7\ \Omega$	85	110	ns
$t_{d(off)}$	Turn-off delay time	(see test circuit)		100	130	ns
$t_f$	Fall time			40	55	ns

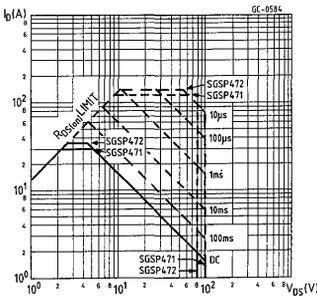
## SOURCE DRAIN DIODE

$I_{SD}$	Source-drain current	for <b>SGSP471</b> for <b>SGSP472</b>			30 35	A A
$I_{SDM}$ (*)	Source-drain current (pulsed)	for <b>SGSP471</b> for <b>SGSP472</b>			120 140	A A
$V_{SD}$	Forward on voltage	$V_{GS} = 0$ $I_{SD} = 30\text{ A}$ for <b>SGSP471</b> $I_{SD} = 35\text{ A}$ for <b>SGSP472</b>			1.35 1.35	V V
$t_{rr}$	Reverse recovery time	$I_{SD} = 35\text{ A}$ $di/dt = 25\text{ A}/\mu\text{s}$	$V_{GS} = 0$		190	ns

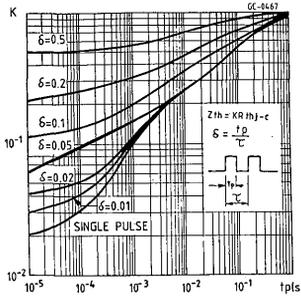
(\*) Pulsed: Pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

(\*) Pulse width limited by safe operating area

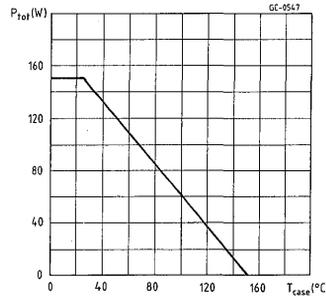
Safe operating areas



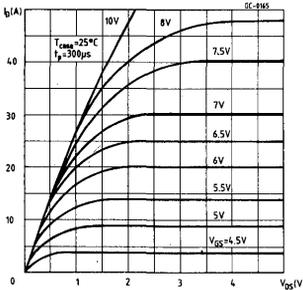
Thermal impedance



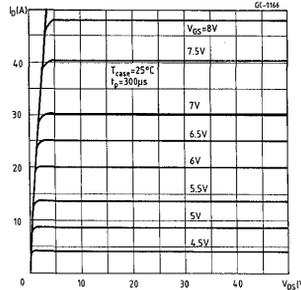
Derating curve



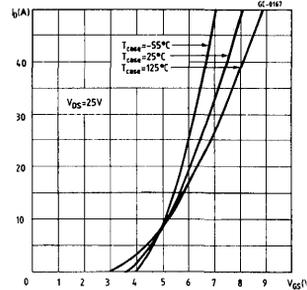
Output characteristics



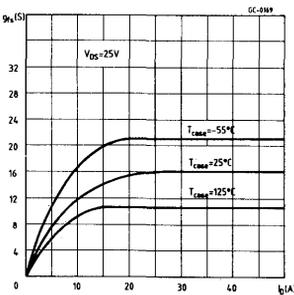
Output characteristics



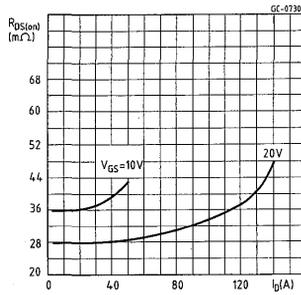
Transfer characteristics



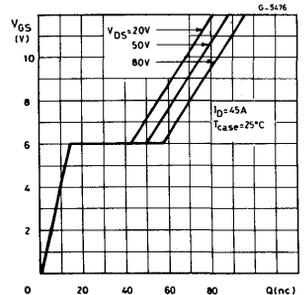
Transconductance



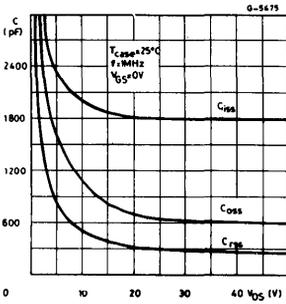
Static drain-source on resistance



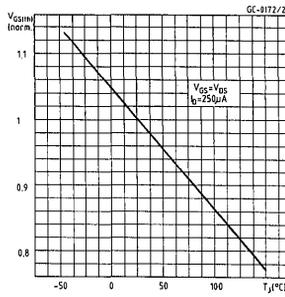
Gate charge vs gate-source voltage



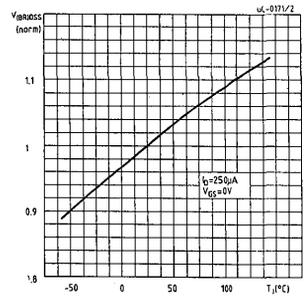
Capacitance variation



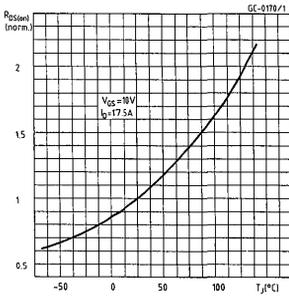
Normalized gate threshold voltage vs temperature



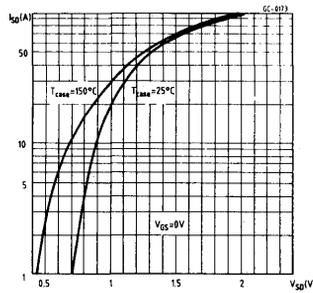
Normalized breakdown voltage vs temperature



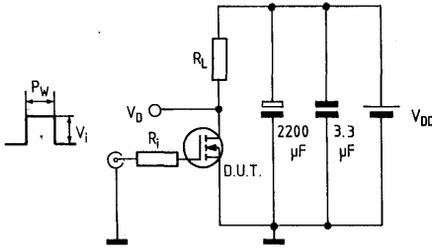
Normalized on resistance vs temperature



Source-drain diode forward characteristics



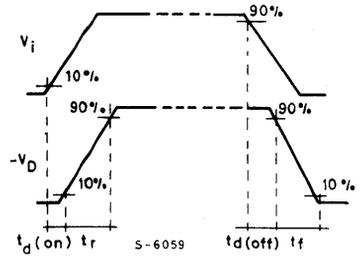
Switching times test circuit for resistive load



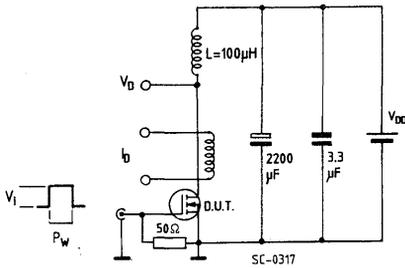
Pulse width  $\leq 100 \mu\text{s}$   
Duty cycle  $\leq 2\%$

SC-0008/1

Switching time waveforms for resistive load



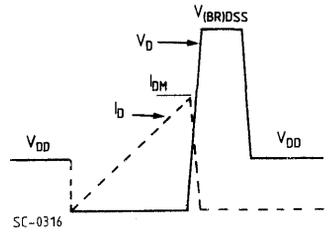
Unclamped inductive load test circuit



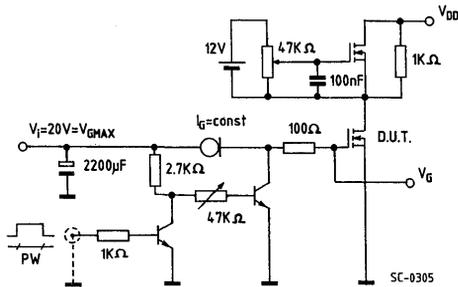
$V_i = 12 \text{ V}$  - Pulse width: adjusted to obtain specified  $I_{DM}$

SC-0317

Unclamped inductive waveforms



Gate charge test circuit



PW adjusted to obtain required  $V_G$

SC-0305

Body-drain diode  $t_{rr}$  measurement  
Jedec test circuit

